

WEST[Help](#)[Logout](#)[Interrupt](#)[Main Menu](#)[Search Form](#)[Posting Counts](#)[Show S Numbers](#)[Edit S Numbers](#)[Preferences](#)[Cases](#)**Search Results -**

Terms	Documents
l2 and l3	2

Database:

US Patents Full-Text Database
 US Pre-Grant Publication Full-Text Database
 JPO Abstracts Database
 EPO Abstracts Database
 Derwent World Patents Index
 IBM Technical Disclosure Bulletins

Search:

L4

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DATE: Monday, April 15, 2002 [Printable Copy](#) [Create Case](#)
Set Name Query
 side by side

Hit Count Set Name
 result set

DB=USPT,PGPB,JPAB,EPAB,DWPI,TDBD; PLUR=YES; OP=ADJ

<u>L4</u>	l2 and l3	2	<u>L4</u>
<u>L3</u>	L1 and (solder or braze) near (difficult or hard to wet or (fe or iron) near (ni or nickel) or ag or silver)	19	<u>L3</u>
<u>L2</u>	L1 and (thick or thickness) near (um or micron or micrometer)	25	<u>L2</u>
<u>L1</u>	(solder or braze) near (dip or immerse or immersion or submerge) and (plate or plated or plating)	525	<u>L1</u>

END OF SEARCH HISTORY

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L7	15 and wave	12	L7
L6	14 and (inert or nitrogen or helium or argon)	86	L6
L5	L4 and ultrasonic	23	L5
L4	L3 and (hard near wet or difficult near (solder or braze or solderable) or (fe or iron near ni or nickel) or aluminum)	186	L4
L3	11 and (thick or thickness or layer) near (um or micron or micrometer)	246	L3
L2	L1 and hot dip	32	L2
L1	(braze or solder) near (dip or immerse or immersion or molten or bath or wave) and (plate or electroplate or plating or electroplating)	4937	L1

END OF SEARCH HISTORY